74AHC1G4208-Q100

8-stage divider and oscillator

Rev. 1 — 3 September 2019

Product data sheet

1. General description

74AHC1G4208-Q100 is a 8-stage divider and oscillator. It consists of a chain of 8 flip-flops. Each flip-flop divides the frequency of the previous flip-flop by two, consequently the 74AHC1G4208-Q100 counts up to 2^8 = 256. The single inverting stage (X1 to X2) functions as a crystal oscillator or an input buffer for an external oscillator. When used as a buffer the output X2 should be left floating. The frequency of the output (Q) is the frequency applied to X1 divided by 256. The divider advances on the negative-going transition of X1.

The X1 input is overvoltage tolerant. This feature allows the use of this device as a voltage level translator in mixed voltage environments.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 2.0 V to 5.5 V
- · Overvoltage tolerant inputs to 5.5 V
- High noise immunity
- · CMOS low power dissipation
- ESD protection:
 - HBM: ANSI/ESDA/Jedec JS-001 exceeds 2000 V
 - CDM: ANSI/ESDA/Jedec JS-002 exceeds 1000 V
 - MIL-STD-883, method 3015 exceeds 2000 V
- Latch-up performance exceeds 100 mA per JESD 78 Class II

3. Ordering information

Table 1. Ordering information

Type number	Package				
	Temperature range	Name	Description	Version	
74AHC1G4208GW-Q100	-40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1	

4. Marking

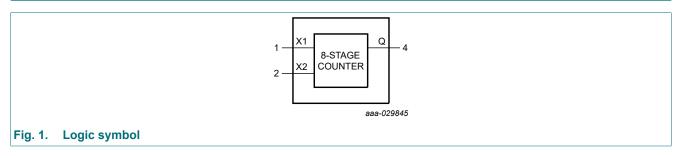
Table 2. Marking codes

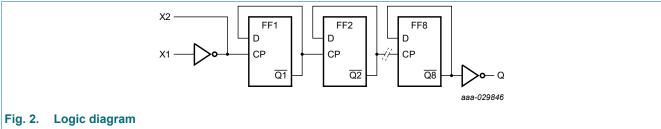
Type number	Marking[1]
74AHC1G4208GW-Q100	C5

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.



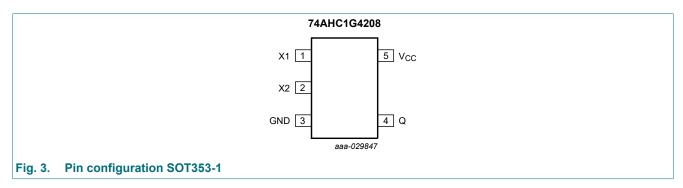
5. Functional diagram





6. Pinning information

6.1. Pinning

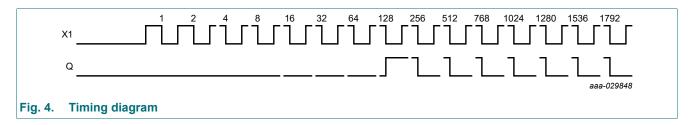


6.2. Pin description

Table 3. Pin description

Symbol	Pin	Description
X1	1	clock input/oscillator pin
X2	2	oscillator pin
GND	3	ground (0 V)
Q	4	divider output
V _{CC}	5	supply voltage

7. Functional description



8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7.0	V
VI	input voltage		-0.5	+7.0	V
I _{IK}	input clamping current	V _I < -0.5 V	-20	-	mA
I _{OK}	output clamping current	$V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}$ [1]	-	±20	mA
Io	output current	-0.5 V < V _O < V _{CC} + 0.5 V	-	±25	mA
I _{CC}	supply current		-	75	mA
I _{GND}	ground current		-75	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$ [2]	-	250	mW

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

9. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		2.0	5.0	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage		0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	°C
Δt/ΔV	input transition rise and fall	V _{CC} = 3.3 V ± 0.3 V	-	-	100	ns/V
	rate	V _{CC} = 5.0 V ± 0.5 V	-	-	20	ns/V

^[2] For SOT353-1 (TSSOP5) package: above 74 °C the value of Ptot derates linearly with 3.3 mW/K.

10. Static characteristics

Table 6. Static characteristics

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	1
V _{IH}	HIGH-level	X1								
	input voltage	V _{CC} = 2.0 V	1.7	-	-	1.7	-	1.7	-	V
		V _{CC} = 3.0 V	2.4	-	-	2.4	-	2.4	-	V
		V _{CC} = 5.5 V	4.4	-	-	4.4	-	4.4	-	V
V _{IL}	LOW-level	X1								
	input voltage	V _{CC} = 2.0 V	-	-	0.3	-	0.3	-	0.3	V
		V _{CC} = 3.0 V	-	-	0.6	-	0.6	-	0.6	V
		V _{CC} = 5.5 V	-	-	1.1	-	1.1	-	1.1	V
V _{OH}	HIGH-level	$Q; V_I = V_{IH} \text{ or } V_{IL}$								
	output voltage	I _O = -50 μA; V _{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I _O = -50 μA; V _{CC} = 3.0 V	2.9	3.0	-	2.9	-	2.9	-	V
		I _O = -50 μA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		$I_O = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.58	-	-	2.48	-	2.40	-	V
		I _O = -8.0 mA; V _{CC} = 4.5 V	3.94	-	-	3.8	-	3.70	-	V
		X2; V _I = V _{IH} or V _{IL}								
		I _O = -50 μA; V _{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I _O = -50 μA; V _{CC} = 3.0 V	2.9	3.0	-	2.9	-	2.9	-	V
		I _O = -50 μA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -2.0 mA; V _{CC} = 3.0 V	2.58	-	-	2.48	-	2.40	-	V
		$I_O = -3.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.94	-	-	3.8	-	3.70	-	V
V _{OL}	LOW-level	Q; $V_I = V_{IH}$ or V_{IL}								
	output voltage	I _O = 50 μA; V _{CC} = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 50 μA; V _{CC} = 3.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 50 μA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
		$I_O = 8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
		X2; V _I = V _{IH} or V _{IL}								
		I _O = 50 μA; V _{CC} = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 50 μA; V _{CC} = 3.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 50 μA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
	$I_O = 2.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V	
	$I_O = 3.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V	
I _I	input leakage current	X1; V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	1.0	-	10	-	40	μA
Cı	input capacitance	X1	-	3	8	-	8	-	8	pF

11. Dynamic characteristics

Table 7. Dynamic characteristics

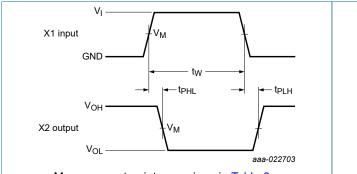
GND = 0 V; $t_r = t_f = \le 3.0$ ns. For test circuit see Fig. 7. For waveforms see Fig. 5 and Fig. 6.

Symbol	Parameter	Conditions			25 °C		-40 °C t	o +85 °C	-40 °C t	o +125 °C	Unit
				Min	Тур	Max	Min	Max	Min	Max	1
t _{pd}	propagation	X1 to X2	[1]								
	delay	V _{CC} = 3.0 V to 3.6 V	[2]								
		C _L = 15 pF		-	3	7	1	11	1	13	ns
		C _L = 50 pF		-	7	13	1	16	1	18	ns
		V _{CC} = 4.5 V to 5.5 V	[3]								
		C _L = 15 pF		-	2	5	1	7	1	9	ns
		C _L = 50 pF		-	6	10	1	11	1	12	ns
		X1 to Q	[1]								
		V _{CC} = 3.0 V to 3.6 V	[2]								
		C _L = 15 pF		-	19	32	1	42	1	49	ns
		C _L = 50 pF		-	21	36	1	46	1	55	ns
		V _{CC} = 4.5 V to 5.5 V	[3]								
		C _L = 15 pF		-	14	23	1	29	1	34	ns
		C _L = 50 pF		-	16	25	1	32	1	38	ns
t _W	pulse width	X1 HIGH or LOW									
		V _{CC} = 3.0 V to 3.6 V		4	-	-	5	-	7	-	ns
		V _{CC} = 4.5 V to 5.5 V		3	-	-	4	-	5	-	ns
f _{max}	maximum	X1									
	frequency	V _{CC} = 3.3 V		125	-	-	100	-	70	-	MHz
		V _{CC} = 5 V		165	-	-	125	-	100	-	MHz
C _{PD}	dissipation	C_L = 50 pF; f_i = 1 MHz; V_I = GND to V_{CC}	[4]								
	capacitance	V _{CC} = 3.3 V		-	4	-	-	-	-	-	pF
		V _{CC} = 5 V		-	5	-	-	-	-	-	pF

 f_i = input frequency in MHz; C_L = output load capacitance in pF; V_{CC} = supply voltage in Volt.

 t_{pd} is the same as t_{PLH} and t_{PHL} . Typical values are measured at V_{CC} = 3.3 V. Typical values are measured at V_{CC} = 5.0 V. C_{PD} is used to determine the dynamic power dissipation P_D (µW). $P_D = C_{PD} \times V_{CC}^2 \times f_i + C_L \times V_{CC}^2 \times f_i/256$ where:

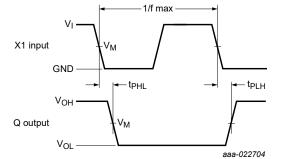
11.1. Waveforms and test circuit



Measurement points are given in <u>Table 8</u>.

 $\ensuremath{V_{OL}}$ and $\ensuremath{V_{OH}}$ are typical output voltage levels that occur with the output load.

Fig. 5. Input X1 to output X2 propagation delay times



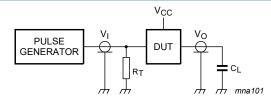
Measurement points are given in <u>Table 8</u>.

 V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 6. Input X1 to output Q propagation delay times

Table 8. Measurement points

Inputs	Output	
V _I	V _M	V _M
GND to V _{CC}	0.5 × V _{CC}	0.5 × V _{CC}



Test data is given in Table 7. Definitions for test circuit:

C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

Fig. 7. Test circuit for measuring switching times

12. Crystal oscillator

12.1. Typical crystal oscillator circuit

A typical crystal oscillator schematic is shown in Fig. 8. R1 is the power limiting resistor, its value depends on the frequency and required stability against changes in V_{CC} or average I_{CC} . For starting and maintaining oscillation a minimum transconductance is necessary, so R1 should not be too large. A practical value for R1 is 2.2 k Ω .

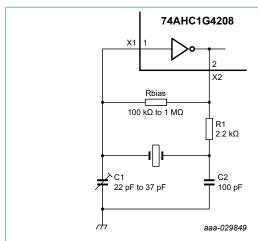
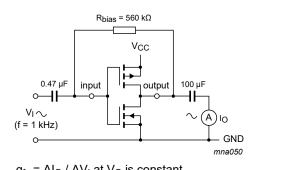
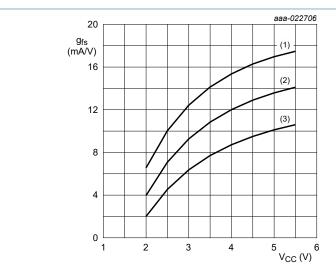


Fig. 8. External component connection for a crystal oscillator



 $g_{fs} = \Delta I_O / \Delta V_I$ at V_O is constant. See also Fig. 10.

Fig. 9. Test set-up for measuring forward transconductance

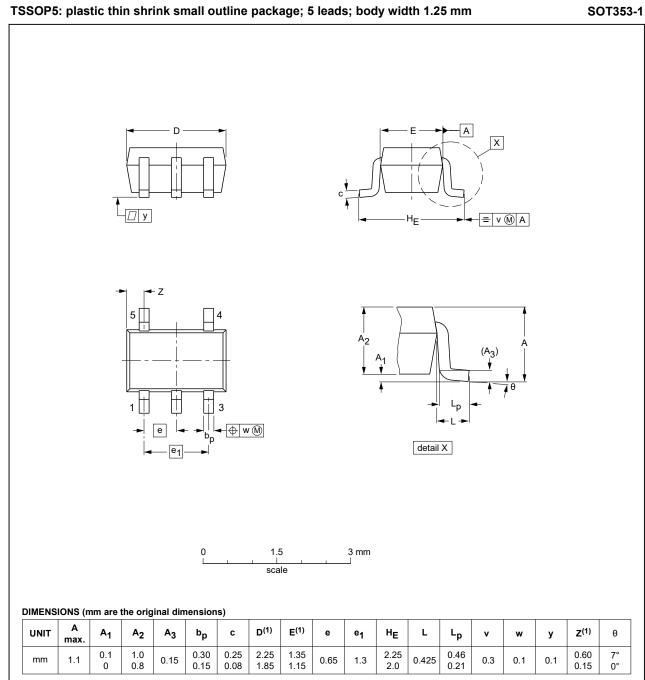


 T_{amb} = 25 °C.

- (1) Maximum.
- (2) Typical.
- (3) Minimum.

Fig. 10. Typical forward transconductance as function of the supply voltage

13. Package outline



Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT353-1		MO-203	SC-88A			00-09-01 03-02-19

Fig. 11. Package outline SOT353-1 (TSSOP5)

14. Abbreviations

Table 9. Abbreviations

Acronym	Description	
CDM	Charged Device Model	
DUT	evice Under Test	
ESD	ElectroStatic Discharge	
НВМ	Human Body Model	
MIL	Military	
MM	Machine Model	

15. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AHC1G4208_Q100 v.1	20190903	Product data sheet	-	-

16. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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Product data sheet

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